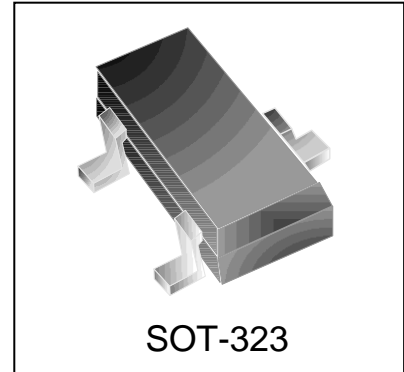


## NPN Silicon Transistor

### Features

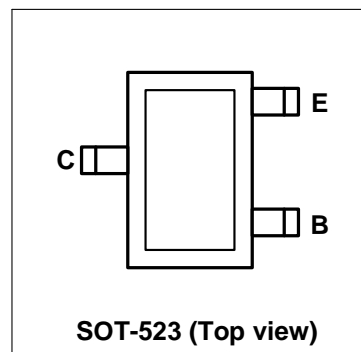
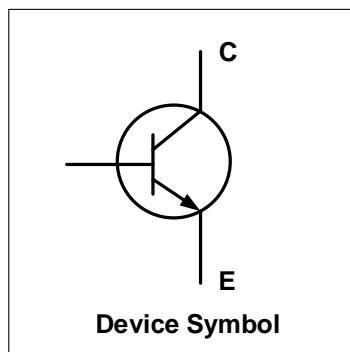
- Small Package
- Collector Current:  $I_C=0.5A$
- For High-Speed Switching Applications
- Low Current Leakage



### Mechanical Characteristics

- SOT-323 Package
- Marking : Making Code
- RoHS Compliant

### Schematic & PIN Configuration



### Absolute Maximum Rating

Parameter	Symbol	Value	Unit
Collector Base Voltage	$V_{CBO}$	50	V
Collector Emitter Voltage	$V_{CEO}$	45	V
Emitter Base Voltage	$V_{EBO}$	5	V
Collector Current	$I_C$	0.5	A
Collector Power Dissipation	$P_C$	200	mW
Junction Temperature	$T_j$	150	°C
Storage Temperature	$T_{stg}$	-55 ~ 150	°C
Thermal Resistance from Junction To Ambient	$R_{\theta JA}$	625	°C/W

**Electrical Characteristics (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C = 10\mu A, I_E = 0$	50	-	-	V
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	$I_C = 10mA, I_B = 0$	45	-	-	V
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E = 1\mu A, I_C = 0$	5	-	-	V
Collector Cut-off Current	$I_{CBO}$	$V_{CB} = 20V, I_E = 0$	-	-	100	nA
Emitter Cut-off Current	$I_{EBO}$	$V_{EB} = 5V, I_C = 0$	-	-	100	nA
DC Current Gain	$h_{FE(1)}$	$V_{CE} = 1V, I_C = 100mA$	160	-	400	-
	$h_{FE(2)}$	$V_{CE} = 1V, I_C = 500mA$	40	-	-	-
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = 500mA, I_B = 50mA$	-	-	1.2	V
Base-Emitter Voltage	$V_{BE(on)}$	$V_{CE} = 1V, I_C = 500mA$	-	-	1.2	V
Transition Frequency	$f_T$	$V_{CE} = 5V, I_C = 10mA, f = 100MHz$	100	-	-	MHz
Collector Output Capacitance	$C_{ob}$	$V_{CB} = 10V; f = 1MHz$	-	8.5	-	pF

**Typical Characteristics**

Figure 1. Static Characteristics

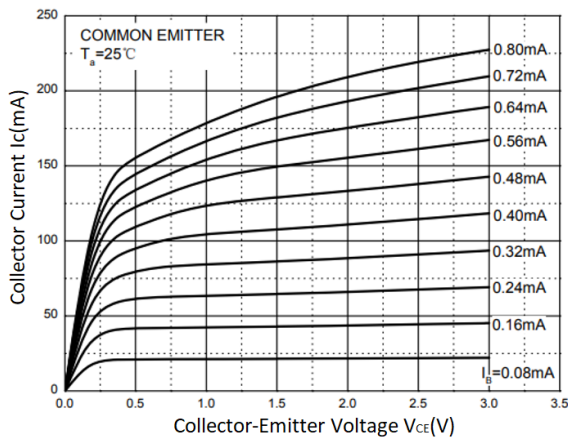


Figure 2.  $h_{FE}$  vs.  $I_C$

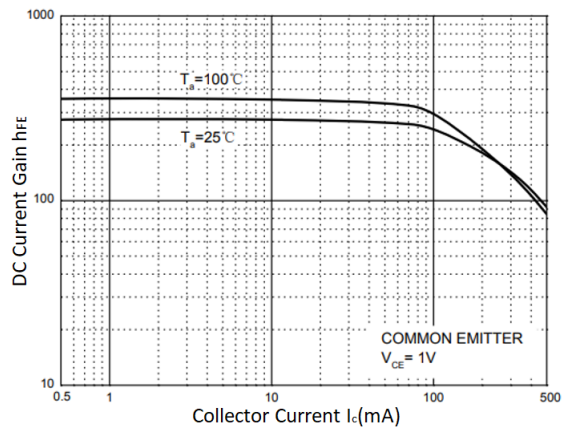


Figure 3.  $V_{BE(sat)}$  vs.  $I_c$

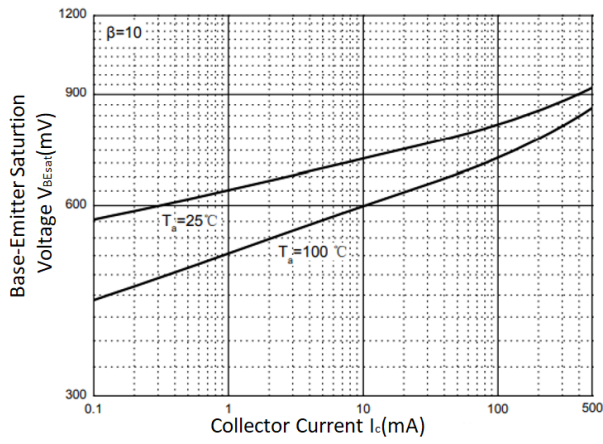


Figure 4.  $V_{CE(sat)}$  vs.  $I_c$

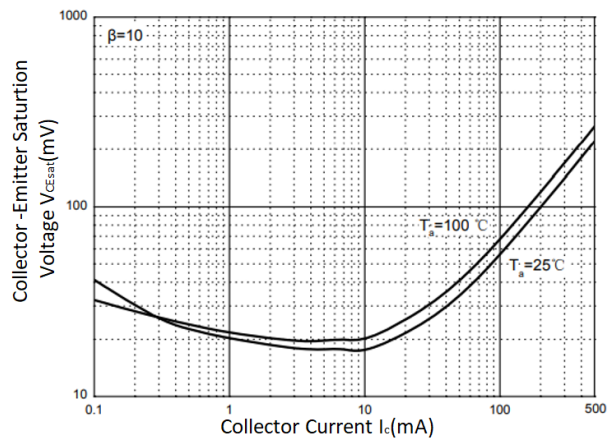


Figure 5.  $I_c$  vs.  $V_{BE}$

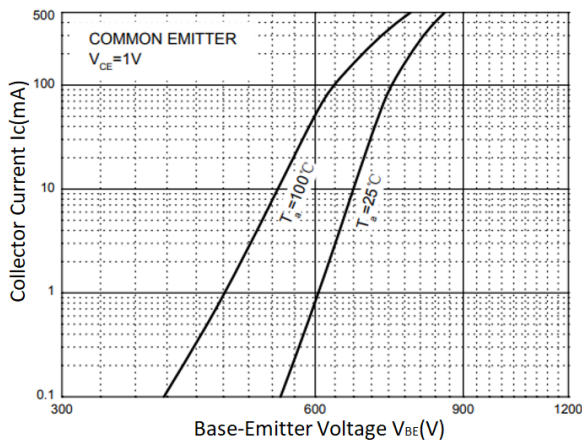


Figure 6.  $f_T$  vs.  $I_c$

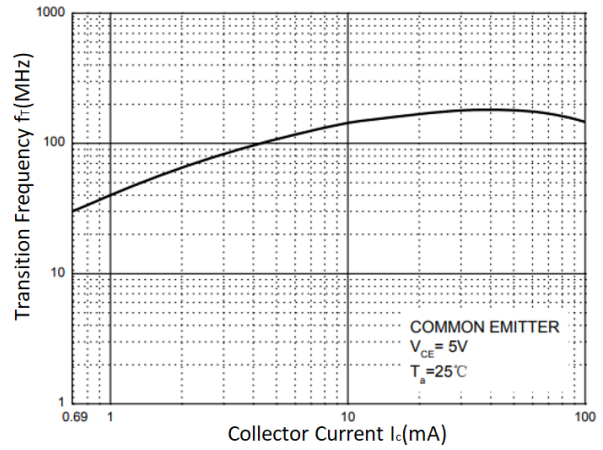


Figure 7.  $C_{ob} / C_{ib}$  vs.  $V_{CB} / V_{EB}$

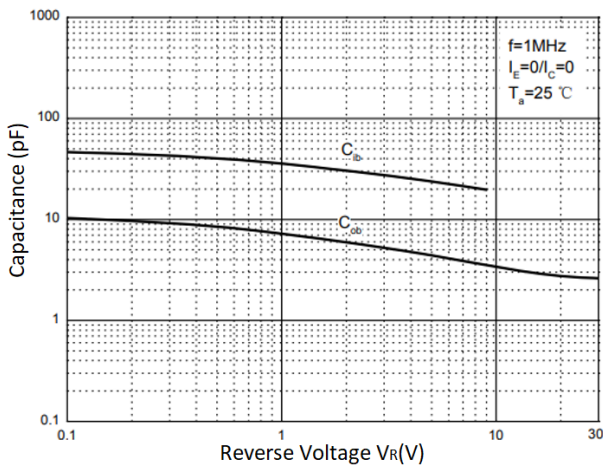
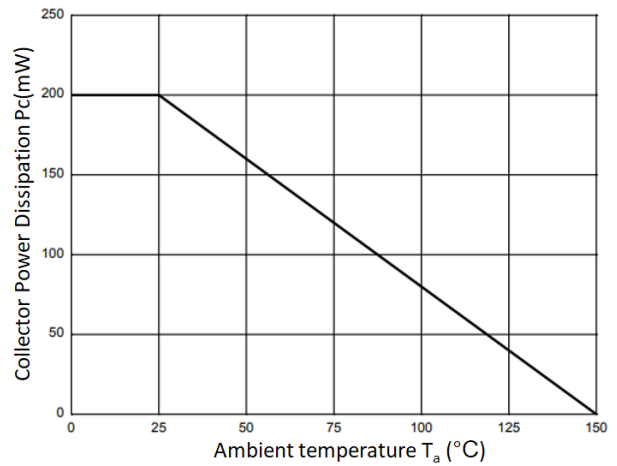


Figure 8.  $P_C$  vs.  $T_a$



Outline Drawing – SOT-323

### PACKAGE OUTLINE

**SOT-323**

DIMENSIONS				
SYMBOL	MILLIMETER		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
D	2.000	2.200	0.079	0.087
b	0.300	0.500	0.012	0.020
c	0.100	0.150	0.004	0.006
E	2.150	2.450	0.085	0.096
E1	1.150	1.350	0.045	0.053
e	0.650TYP		0.026TYP	
L	0.525 REF		0.021 REF	
$\theta$	0	8°	0	8°

DIMENSIONS		
DIM	INCHES	MILLIMETERS
M	0.076	1.90
C	0.036	0.9
Z	0.108	2.7
e	0.026	0.65
e1	0.052	1.30
b	0.028	0.7

**Notes**

1. Dimensioning and tolerances per ANSI Y14.5M, 1985.
2. Controlling Dimension: Inches
3. Pin 3 is the cathode (Unidirectional Only).
4. Dimensions are exclusive of mold flash and metal burrs.

Marking Codes

Part Number	WT817G
Marking Code	

Package Information

Qty: 3k/Reel

CONTACT INFORMATION

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For additional information, please contact your local Sales Representative.

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Specifications are subject to change without notice.  
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.  
Users should verify actual device performance in their specific applications.

单击下面可查看定价，库存，交付和生命周期等信息

[>>WAY-ON\(维安\)](#)